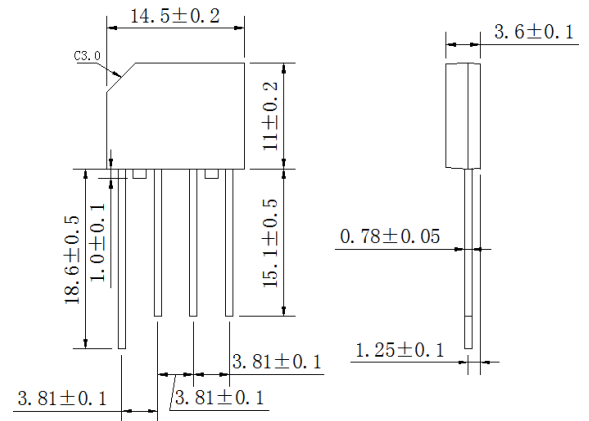


■ Features

- Ideal for printed circuit board mounting
- The plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- Built-in printed circuit board stand-offs
- High case dielectric strength
- High temperature soldering guaranteed
265°C/10 seconds at 5 lbs (2.3kg) tension

■ Mechanical Data

- Case: Reliable low cost construction utilizing molded plastic technique
- Terminals: Plated leads solderable per MIL-STD-202, Method 208
- Mounting Position: Any



Dimensions in inches and (millimeters)

■ Maximum Ratings & Thermal Characteristics

CHARACTERISTICS	SYMBOL	KBP2005	KBP201	KBP202	KBP204	KBP206	KBP208	KBP210	UNIT
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	30	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified output Current at T _a =40°C	I _{F(AV)}	2							A
Peak Forward Surge Current Single Sine-Wave SuperImposed on Rated Load (JEDEC Method)	I _{FSM}	30							A
Operating junction and storage temperature range	T _J T _{STG}	-55 to +150							°C

Notes: Rating at 25°C ambient temperature unless otherwise specified, Resistive or Inductive load, 60 Hz. For Capacitive load derate current by 20%.

■ Electrical Characteristics

Parameter	Symbol	KBP2005	KBP201	KBP202	KBP204	KBP206	KBP208	KBP210	Unit
Maximum instantaneous forward voltage drop per leg at 2.0A	V _F	1.1							V
Maximum DC reverse current at rated DC blocking voltage per element T _A =25°C T _A =125°C	I _R	10 500							uA

Notes: Rating at 25°C ambient temperature unless otherwise specified, Resistive or Inductive load, 60 Hz. For Capacitive load derate current by 20%
Measured at 2.0MHz and applied reverse voltage of 4.0 volts



■ Rating and Characteristic Curves (TA=25°C Unless otherwise noted)

Fig. 1 Derating Curve for Output Rectified Current

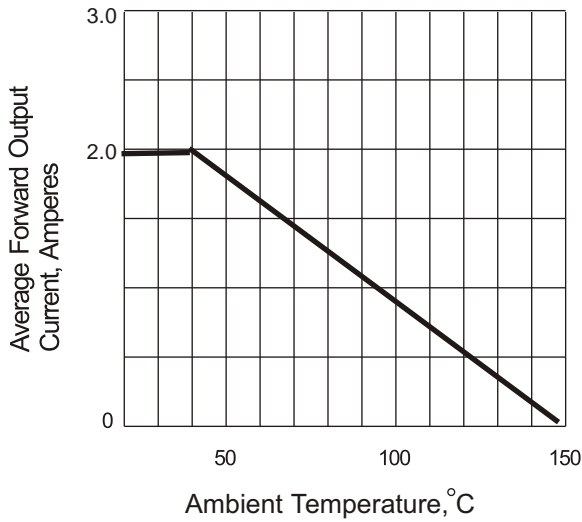


Fig. 2 Maximum Non-repetitive Peak Forward Surge Current

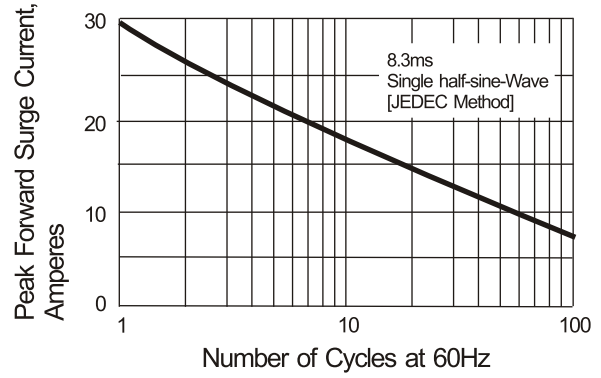


Fig. 3 Typical Instantaneous Forward Characteristics

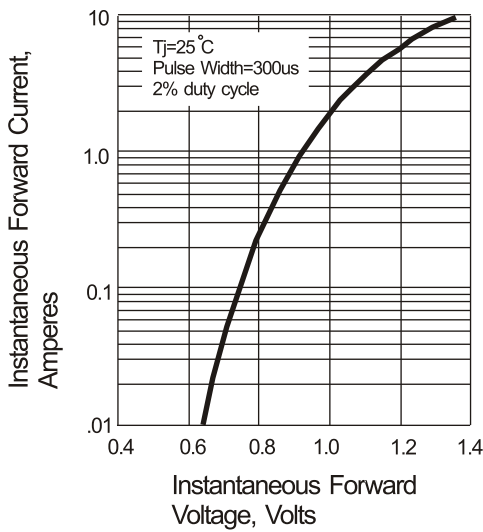


Fig. 4 Typical Reverse Characteristics

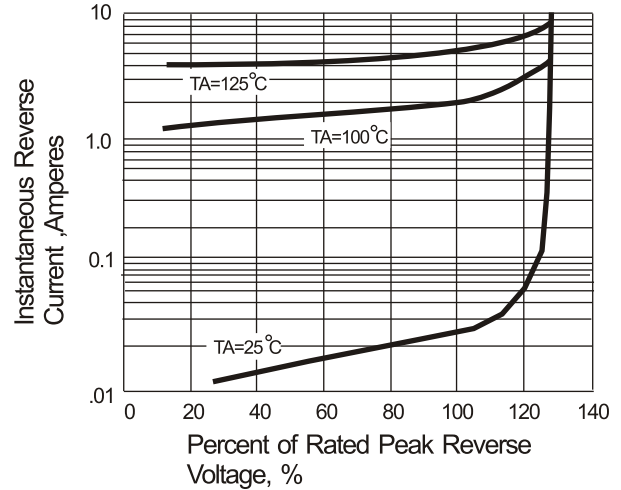


Fig. 5 Typical Junction Capacitance

